

22.07.2011

### **DEM 132038A FGH-PW**

# **DOCUMENT REVISION HISTORY**

Version	DATE	DESCRIPTION	CHANGED BY
0	Jul-19-2011	First issue	
1	Jul-22-2011	Update dimensional outline at p3	

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# **<u>1. FUNCTIONS & FEATURES</u>**

Format LCD mode Viewing direction Driving scheme Power supply voltage (V<sub>DD</sub>) LCD driving voltage (VLCD) Operation temp Storage temp Backlight color : 132 x 38 Dots : FSTN / Positive/ Transflective Mode : 6 o'clock : 1/49 Duty cycle, 1/6 Bias : 3.3Volt (typ.) : 8.5Volt (typ.) : -20 to +70°C : -25 to +80°C : LED, Lightguide, White

# **2. MECHANICAL SPECIFICATIONS**

Module size Viewing area

: 104.0 x 37.5 mm (without FPC) : 91.5 x 26.5 mm

# **3. BLOCK DIAGRAM**

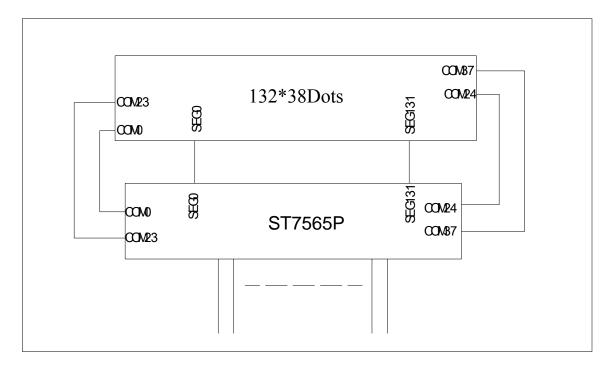


Figure 1. Block diagram

# **4. DIMENSIONAL OUTLINE**

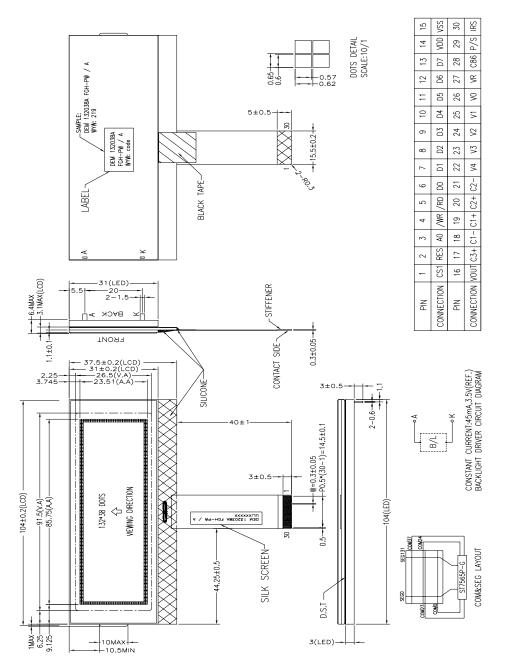


Figure 2. Dimensional outline

### 5. LCD Driving voltage generator and bias reference circuit

When the voltage regulator internal resistor is not used. (Example where VDD2=VDD, with  $4 \times$  step-up)

1. When used all of the step-up circuit, voltage regulating circuit and V/F circuit

(2) When the voltage regulator internal resistor (1) When the voltage regulator internal resistor is used. is not used. (Example where VDD2 = VDD, with 4x step-up) (Example where VDD2 = VDD, with 4x step-up)  $t^{v_{\text{DD}}}$ Vss ▲ VDD M/S IRS M/S IRS VDD2 or VSS VDD2 er VSS VDD or VSS ¥VDDαVSS C1+ C1+ Vout Vout CAP3P CAP4P CAP3P CAP4P C1+ C1: CAP5P CAP1N CAP5P CAP1N C1 C1 CAP1P CAP1P CAP2N CAP2N C1 C1 CAP2P Т CAP2P R3 ST7565F ST7565F vo V5 VR  $R^2$ VR R1 Vss <u>C2</u>11 C2 V0 V0 C2 V1 C2 V1 C2 C2 V2 V2 C2 C2 V3 V3 <u>C2</u> C2 V4 V4 VDD2 or Vss VDD2 or Vss

NOTE: Reference circuit used 4 times booster circuit .

■Recommended component values:C1: 1.0 to 4.7uF ; C2: 0.47~1.0uF

- ■C1,C2 is determined by the size of the LCD being driven. Select a value that will stabilize the liquid crystal drive voltage.
- Ra and Rb maybe changed in mass productions to keep the consistency of display contrast.

# **6. PIN DESCRIPTION**

No.	Symbol	Function
1	CS1	This is the chip select signal. When /CS1 ="L", then the chip select
	CS1	becomes active, and data/command I/O is enabled
2	RES	When /RES is set to "L", the setting are initialized
		This is connected to the least significant bit of the normal MPU
3	A0	address bus, and it determines whether the data bits are data
		or a command
		• When connected to 8080 series MPU, this pin is treated as the
		"/WR" signal of the8080 MPU and is LOW-active.
		The signals on the data bus are latched at the rising edge of the /WR
4	/WR(RW)	signal.• When connected to 6800 series MPU, this pin is treated as the
		"R/W" signal of the 6800 MPU and decides the access type :
		When $R/W = "H"$ : Read.
		When $R/W = "L"$ : Write.
		When connected to 8080 series MPU, this pin is treated as the "/RD"
		signal of the 8080 MPU and is LOW-active. The data bus is in an
5	/RD(E)	output status when this signal is "L".• When connected to 6800 series
5	/KD(E)	MPU, this pin is treated as the "E" signal of the
		6800 MPU and is HIGH-active. This is the enable clock input terminal
		of the 6800 Series MPU.
		This is an 8-bit bi-directional data bus that connects to an 8-bit or 16-
		bit standard MPU data bus.
		When the serial interface (SPI-4) is selected ( $P/S = "L"$ ):
6-13	D0~D7	D7 : serial data input (SI) ; D6 : the serial clock input (SCL).
		D0 to D5 should be connected to VDD or floating.
		When the chip select is not active, D0 to D7 are set to high
		impedance.
14	VDD	Power supply for logic(+3.0V)
15	VSS	Power ground
16	VOUT	DC/DC voltage converter.

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17-21	C3+, C1-, C1+, C2+, C2-,	DC/DC voltage converter output
22.20	V4,V3,V2,V1,	The DC/DC voltage converter output is is a multi-level power supply
22-26	V0	for the liquid crystal drive.
27	VR	Output voltage regulator terminal. Provides the voltage between VSS and V0 through a resistive voltage divider. IRS = "L" : the V0 voltage regulator internal resistors are not used. IRS = "H" : the V0 voltage regulator internal resistors are used.
28	C86	This is the MPU interface selection pin. C86 = "H": 6800 Series MPU interface. C86 = "L": 8080 Series MPU interface.
29	P/S	This pin configures the interface to be parallel mode or serial mode. P/S = "H": Parallel data input/output. P/S = "L": Serial data input.
30	IRS	This terminal selects the resistors for the V0 voltage level adjustment. IRS = "H": Use the internal resistors IRS = "L": Do not use the internal resistors. The V0 voltage level is regulated by an external resistive voltage divider attached to the VR terminal

# 7. MAXIMUM ABSOUTE LIMIT

### Maximum Ratings (Voltage Reference to VSS)

Item	Symbol	MIN	MAX	Unit
Supply Voltage for Logic	Vdd	-0.3	3.6	V
Supply Voltage for LCD	V0	0.3	14.5	V
Operating Temperature	Тор	-20	70	°C
Storage Temperature	Tst	-25	80	°C

# **8. ELECTRICAL CHARACTERISTICS**

### DC Electrical Characteristics (VDD=3.3V,VSS=0V,T<sub>A</sub>=25°C)

14.0		Cumple of	C	diti e u		Rating		Units	Applicable												
lte	m	Symbol	Cor	ndition	Min.	Тур.	Max.	Units	Pin												
Operating '	Voltage (1)	VDD													1.8	_	3.3	V	V <sub>SS</sub> *1		
Operating '	Voltage (2)	VDD2	(Relative to	(Relative to Vss)		_	3.3	V	V <sub>SS</sub>												
High-level Ir	gh-level Input Voltage		нс		0.8 x V <sub>DD</sub>	_	V <sub>DD</sub>	V	*3												
Low-level In	put Voltage	VILC			Vss	_	0.2 x V <sub>DD</sub>	V	*3												
High-level Ou	utput Voltage	Vонс	юн = -0.5 mA		юн = -0.5 mA		юн = –0.5 mA		юн = –0.5 mA		IOH = -0.5 mA		с Іон = –0.5 mA		Iон = –0.5 mA		0.8 x V <sub>DD</sub>	_	Vdd	V	*4
Low-level Ou	itput Voltage	Volc	VOLC IOL = 0.5 mA		IOL = 0.5 mA		V <sub>ss</sub>	_	0.2 x V <sub>DD</sub>	V	*4										
Input leaka	ige current	LI	VIN = VDD or VSS		-1.0	_	1.0	μA	*5												
Output leak	age current	ILO	VIN = VDD (		-3.0	_	3.0	μA	*6												
Liquid Cryst	al Driver ON	Davi	Ta = 25°C	V <sub>0</sub> = 13.0 V	_	2.0	3.5	ΚΩ	SEGn												
Resis		Ron	(Relative to V <sub>ss</sub> )	V <sub>0</sub> = 8.0 V	—	3.2	5.4		COMn *7												
Input Termina	l Capacitance	Cin	Ta = 25°C	, f = 1 MHz	_	5.0	8.0	pF													
	Internal Oscillator	fosc	1/65 duty To - 25°C		17	20	24	kHz	*8												
Oscillator	External for 1/33 duty				17	20	24	kHz	CL												
Frequency															25	30	35	kHz	*8		
					30	35	kHz	CL													

	ltem	Symbol	Condition		Rating	Units	Applicable	
	nem	Symbol	Condition	Min.	Тур.	Max.	Units	Pin
	Input voltage	Vdd2	(Relative to Vss)	2.4	—	3.3	V	Vss
	Supply Step-up output voltage Circuit	Vout	(Relative to Vss)	_	_	13.5	V	Vout
al Power	Voltage regulator Circuit Operating Voltage	Vout	(Relative to Vss)	6.0	_	13.5	V	Vout
Internal	Voltage Follower Circuit Operating Voltage	V0	(Relative to Vss)	4.0		13.0	V	V0 * 9
	Base Voltage	Vr	Ta = 25°C , (Relative to Vss) –0.05%/°C	2.07	2.10	2.13	V	*10

### 9. TIMING CHARACTERISTICS

System Bus Read/Write Characteristics 1 (For the 8080 Series MPU)

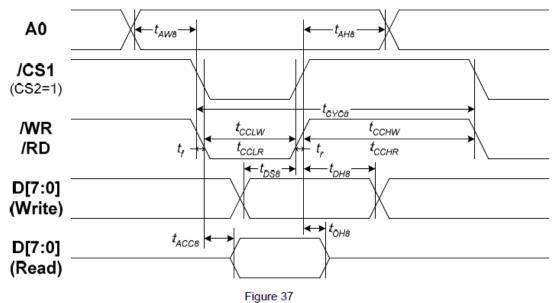
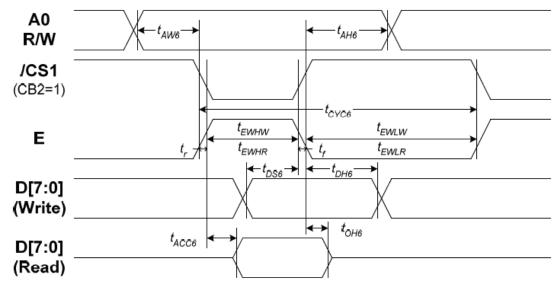


Figure 57

Table 24

				VDD =3.3V,	Ta = -30 to	o 75°C)
ltem	Signal	Symbol	Condition	Rat	ing	Units
	Signal	Symbol	condition	Min.	Max.	onits
Address hold time		tah8		0	_	
Address setup time	A0	tAW8		0	_	
System cycle time		tcyc8		240	—	
Write L pulse width	/WR	tCCLW		80	_	
Write H pulse width		tcchw		80	_	]
Read L pulse width	/RD	<b>t</b> CCLR		140	_	Ns
Read H pulse width		<b>t</b> CCHR		80		]
Write Data setup time		tDS8		40	_	
Write Address hold time	D0 to D7	tdh8		0	_	]
Read access time		tACC8	CL= 100 pF	_	70	
Read Output disable time	1	tонв	CL = 100 pF	5	50	



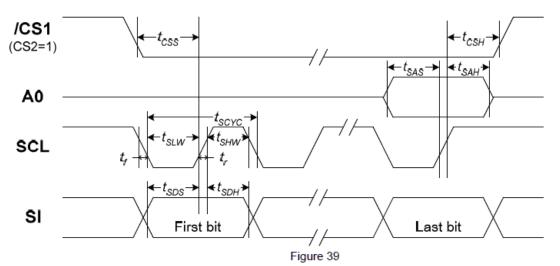
System Bus Read/Write Characteristics 2 (For the 6800 Series MPU)

Figure 38

```
Table 27
```

		Table		(VDD = 3.3V,	Ta = -30 to	o 75℃)
ltem	Signal	Symbol	Condition	Rat	Units	
	Signal	Symbol	Condition	Min.	Max.	onits
Address hold time		tah6		0	_	
Address setup time	A0	tAW6		0	—	
System cycle time		tcyc6		240	—	
Enable L pulse width (WRITE)		tEWLW		80	_	
Enable H pulse width (WRITE)	- E	<b>t</b> EWHW		80	_	
Enable L pulse width (READ)		tewlr		80	_	ns
Enable H pulse width (READ)		<b>t</b> EWHR		140		
WRITE Data setup time		tDS6		40	_	]
WRITE Address hold time	- D0 to D7	tDH6		0	_	]
READ access time		tACC6	CL = 100 pF	—	70	]
READ Output disable time		tOH6	CL = 100 pF	5	50	]

#### The Serial Interface

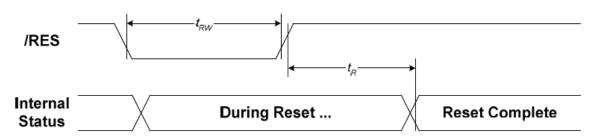


#### Table 30

			. (	VDD = 3.3V,	Ta = -30 to	o 75℃)
ltem	Signal	Symbol	Condition	Rat	Units	
Kenn	Signal	Symbol	condition	Min.	Max.	Units
Serial Clock Period		tsovo		50	_	
SCL "H" pulse width	SCL	t <sub>sнw</sub>		25	-	
SCL "L" pulse width		t <sub>sLW</sub>		25	_	1
Address setup time	A0	tsas		20	_	]
Address hold time	AU	t <sub>SAH</sub>		10	_	ns
Data setup time	SI	t <sub>SDS</sub>		20	_	]
Data hold time	51	t <sub>SDH</sub>		10	_	
CS-SCL time	cs	t <sub>css</sub>		20	_	]
CS-SCL time	05	t <sub>csH</sub>		40	_	

### **10. Reset Timing**

Reset Timing



				(Vc	D = 3.3 V, 1	Ta =30 to	, 75 <b>℃)</b>
ltem	Item Signal Symbol Condition				Units		
nem	Signal	Symbol	Condition	Min.	Тур.	Max.	Units
Reset time	/RES	t <sub>R</sub>		_	_	1.0	μs
Reset "L" pulse width	/IXES	t <sub>RW</sub>		1.0	_	_	μs

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# **11. CONTROL AND DISPLAY INSTRUCTION**

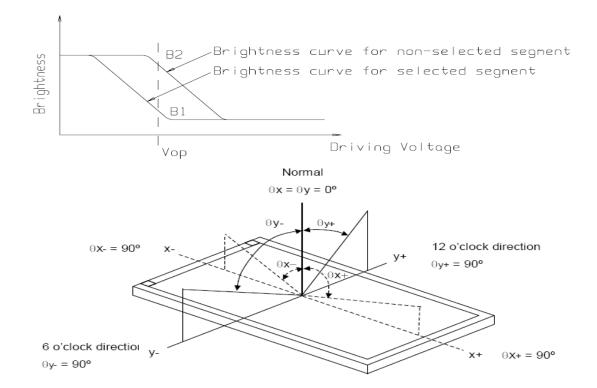
	Command Code							, , ,					
Command	A0	/RD	/WR	D7	D6	D5	D4	D3	3 D2	D	1	D0	Function
(1) Display ON/OFF	0	1	0	1	0	1	0	1	1	1		0 1	LCD display ON/OFF 0: OFF, 1: ON
(2) Display start line set	0	1	0	0	1	Di	spla	ay s	tart a	art address		ss	Sets the display RAM display start line address
(3) Page address set	0	1	0	1	0	1	1	P	age	add	re	SS	Sets the display RAM page address
<ul> <li>(4) Column address set upper bit Column address set lower bit     </li> </ul>	0 0	1 1	0 0	0 0	0 0	0 0	1 0	co Le	ost si lumr ast s lumr	n ad signi	dr ific	ess cant	Sets the most significant 4 bits of the display RAM column address. Sets the least significant 4 bits of the display RAM column address.
(5) Status read	0	0	1		St	atus		0	) (	) (	)	0	Reads the status data
(6) Display data write	1	1	0				Writ	e da	ata				Writes to the display RAM
(7) Display data read	1	0	1				Rea	d da	ata				Reads from the display RAM
(8) ADC select	0	1	0	1	0	1	0	0	0	0		0 1	Sets the display RAM address SEG output correspondence 0: normal, 1: reverse
(9) Display normal/ reverse	0	1	0	1	0	1	0	0	1	1		0 1	Sets the LCD display normal/ reverse 0: normal, 1: reverse
(10) Display all points ON/OFF	0	1	0	1	0	1	0	0	1	0		0 1	Display all points 0: normal display 1: all points ON
(11) LCD bias set	0	1	0	1	0	1	0	0	0	1		0 1	Sets the LCD drive voltage bias ratio 0: 1/9 bias, 1: 1/7 bias (ST7565P)
(12) Read/modify/write	0	1	0	1	1	1	0	0	0	0	)	0	Column address increment At write: +1 At read: 0
(13) End	0	1	0	1	1	1	0	1	1	1		0	Clear read/modify/write
(14) Reset	0	1	0	1	1	1	0	0	0	) 1		0	Internal reset
(15) Common output mode select	0	1	0	1	1	0	0	0 1		*		*	Select COM output scan direction 0: normal direction 1: reverse direction
(16) Power control set	0	1	0	0	0	1	0	1		pera ode		ng	Select internal power supply operating mode
<li>(17) V0 voltage regulator internal resistor ratio set</li>	0	1	0	0	0	1	0	0		esis atio		r	Select internal resistor ratio(Rb/Ra) mode
(18) Electronic volume mode set Electronic volume register set	0	1	0	1 0	0 0	0 Ele	0 ctro	0 nic	0 volu			1 ilue	Set the Vo output voltage electronic volume register
(20) Booster ratio set	0	1	0	1 0	1 0	1 0	1 0	1 0		ste	ep	0 -up ue	select booster ratio 00: 2x,3x,4x 01: 5x 11: 6x
(21) Power saver													Display OFF and display all points ON compound command
(22) NOP	0	1	0	1	1	1	0	0	0	) 1		1	Command for non-operation
(23) Test	0	1	0	1	1	1	1	1	* *	1	•	*	Command for IC test. Do not use this command

$(VDD=3.3V,Ta=25^{\circ})$										
Item	Symbol	Condition	Min	Тур	Max	Unit				
Operating Voltage for LCD	Vop	Ta =-20°C	-	-	-					
		$Ta = 25^{\circ}C$	-	8.5	-	V				
		$Ta = 70^{\circ}C$	-	-	-					
Response time	Tr	$Ta = 25^{\circ}C$		200	400	ms				
	Tf			250	500	ms				
Contrast	Cr	$Ta = 25^{\circ}C$		5.0						
Viewing angle range	Φ	Cr≥ 2		90						
	θ			45						
	Φ	Cr≥ 2		270						
	θ			45		deg				
	Φ	Cr≥ 2		0						
	θ			30						
	Φ	Cr≥ 2		180						
	θ			45						

# **12. ELECTRO-OPTICAL CHARACTERISTICS**

Brightness of non-selected segment(B2)

Cr= Brightness of selected segment(B1)



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# **13.BACKLIGHT CHARACTERISTICS**

LCD Module with Edge White LED Backlight $Ta = 25^{\circ}C$									
ELECTRICAL RATINGS									
Item	Symbol	Condition	Min	Тур	Max	Unit			
Forward Voltage	VF	IF = 45 mA		3.5		V			
Reverse Current	IR	VR=V				uA			
Luminance (Without LCD)	Lv	IF=45 mA	-	-	-	Cd/m <sup>2</sup>			
wave length (Without LCD)	λρ	IF=45 mA	-	-	-	nm			
Color	White								

When the temperature exceed 2°C the approved current decrease rate for backlight change as the temperature increase is: -0.36x3mA/°C (below 25°C, the current refer to constant, which would not change with temperature ).

## **14. PRECAUTION FOR USING LCD/LCM**

LCD/LCM is assembled and adjusted with a high degree of precision. Do not attempt to make any

alteration or modification. The followings should be noted.

### **General Precautions:**

- 1. LCD panel is made of glass. Avoid excessive mechanical shock or applying strong pressure onto the surface of display area.
- 2. The polarizer used on the display surface is easily scratched and damaged. Extreme care should be taken when handling. To clean dust or dirt off the display surface, wipe gently with cotton, or other soft material soaked with isoproply alcohol, ethyl alcohol or trichlorotriflorothane, do not use water, ketone or aromatics and never scrub hard.
- 3. Do not tamper in any way with the tabs on the metal frame.
- 4. Do not made any modification on the PCB without consulting DISPLAY.
- 5. When mounting a LCM, make sure that the PCB is not under any stress such as bending or twisting. Elastomer contacts are very delicate and missing pixels could result from slight dislocation of any of the elements.
- 6. Avoid pressing on the metal bezel, otherwise the elastomer connector could be deformed and lose contact, resulting in missing pixels and also cause rainbow on the display.
- 7. Be careful not to touch or swallow liquid crystal that might leak from a damaged cell. Any liquid crystal adheres to skin or clothes, wash it off immediately with soap and water.

### **Static Electricity Precautions:**

- 1. CMOS-LSI is used for the module circuit; therefore operators should be grounded whenever he/she comes into contact with the module.
- 2. Do not touch any of the conductive parts such as the LSI pads; the copper leads on the PCB and the interface terminals with any parts of the human body.
- 3. Do not touch the connection terminals of the display with bare hand; it will cause disconnection or defective insulation of terminals.
- 4. The modules should be kept in anti-static bags or other containers resistant to static for storage.
- 5. Only properly grounded soldering irons should be used.
- 6. If an electric screwdriver is used, it should be grounded and shielded to prevent sparks.
- 7. The normal static prevention measures should be observed for work clothes and working benches.
- 8. Since dry air is inductive to static, a relative humidity of 50-60% is recommended.

#### **Soldering Precautions:**

- 1. Soldering should be performed only on the I/O terminals.
- 2. Use soldering irons with proper grounding and no leakage.
- 3. Soldering temperature: 350°C±10°C
- 4. Soldering time: 3 to 4 second.
- 5. Use eutectic solder with resin flux filling.
- 6. If flux is used, the LCD surface should be protected to avoid spattering flux.
- 7. Flux residue should be removed.

### **DEM 122032A FGH-PW**

#### **Operation Precautions:**

- 1. The viewing angle can be adjusted by varying the LCD driving voltage Vo.
- 2. Since applied DC voltage causes electro-chemical reactions, which deteriorate the display, the applied pulse waveform should be a symmetric waveform such that no DC component remains. Be sure to use the specified operating voltage.
- 3. Driving voltage should be kept within specified range; excess voltage will shorten display life.
- 4. Response time increases with decrease in temperature.
- 5. Display color may be affected at temperatures above its operational range.
- 6. Keep the temperature within the specified range usage and storage. Excessive temperature and humidity could cause polarization degradation, polarizer peel-off or generate bubbles.
- 7. For long-term storage over 40°C is required, the relative humidity should be kept below 60%, and avoid direct sunlight.

### **Limited Warranty**

DISPLAY LCDs and modules are not consumer products, but may be incorporated by DISPLAY's customers into consumer products or components thereof; DISPLAY does not warrant that its LCDs and components are fit for any such particular purpose.

- 1. The liability of DISPLAY is limited to repair or replacement on the terms set forth below. DISPLAY will not be responsible for any subsequent or consequential events or injury or damage to any personnel or user including third party personnel and/or user. Unless otherwise agreed in writing between DISPLAY and the customer, DISPLAY will only replace or repair any of its LCD which is found defective electrically or visually when inspected in accordance with DISPLAY general LCD inspection standard . (Copies available on request)
- 2. No warranty can be granted if any of the precautions state in handling liquid crystal display above has been disregarded. Broken glass, scratches on polarizer mechanical damages as well as defects that are caused accelerated environment tests are excluded from warranty.
- 3. In returning the LCD/LCM, they must be properly packaged; there should be detailed description of the failures or defect.